

TAIYO YUDEN

TAIYO YUDEN CO., LTD.

September, 2020

Change Notification of Plating Process Location

Dear Valued Customer,

We are grateful for your continued support.
We have been preparing for change of the location of plating processes for our products in order to ensure stabilization of the plating processes.

By the location change, we will secure enough capacity of production to implement production expansion and will deal with aging of equipment for drainage treatment.

Please refer to the following descriptions of the location change.
Our sales representatives will inform you of detailed information and schedules separately.

Descriptions of plating process location change

- Name of plating process factory: TAIYO YUDEN CHEMICAL TECHNOLOGY CO., LTD.
Address before change: 2947-1, Kuragano-machi, Takasaki-shi, Gunma
Address after change: 927-1, Aza-Nishikawara, Motoyurugido, Fujioka-shi, Gunma
The distance between the two locations: Six kilometers
- Applicable products:
Multilayer Ceramic Capacitors (MLCC);
Multilayer Metal Inductors (MC);
Wound Metal Inductors (ME);
Ceramic RF Device (Filter/Diplexer/Coupler/Chip Antenna);
Devices for Mobile Communications (FBAR/SAW)
- Purpose: Raising capacity of production; Countermeasures for deterioration of the production buildings
- Impact on quality: 5M1E (Man, Machine, Material, Method, Measurement, or Environment) will not be changed.
- Change implementation: Mass-production will be implemented from July 2021 sequentially.
If the schedule is changed, we will inform you.

Request for customer's approval

We would like to kindly request your response to this notification by 30.October, 2020.
If we receive no reply before this date, we will regard this notification as mutually agreed.

Date _____ Company Name, Signature _____